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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	CPU32
Core Size	32-Bit Single-Core
Speed	16MHz
Connectivity	EBI/EMI, SCI, SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	16
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	-
Data Converters	-
Oscillator Type	External, Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68lk332gcag16

1.3 Pin Assignments

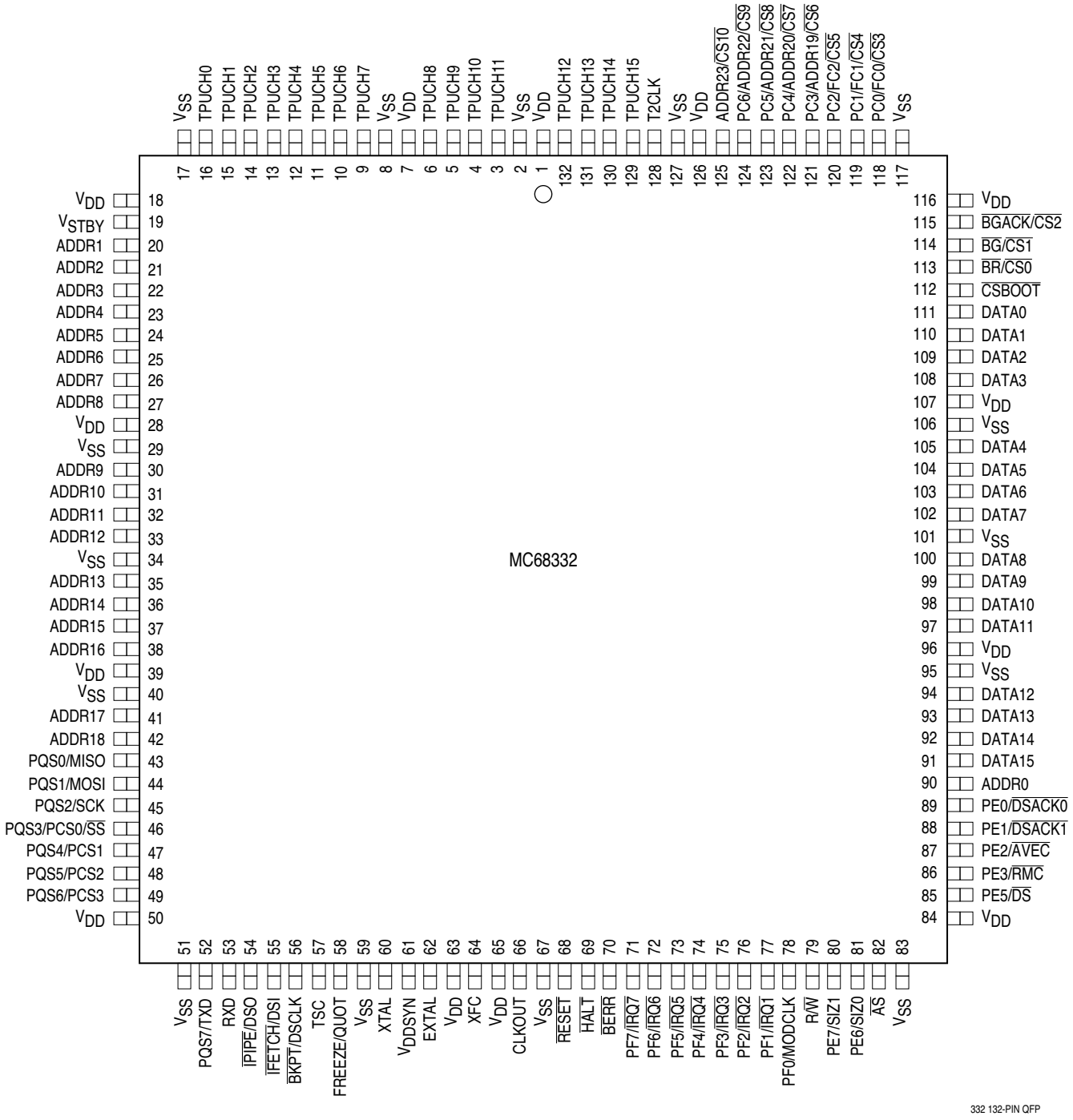


Figure 2 MC68332 132-Pin QFP Pin Assignments

2 Signal Descriptions

2.1 Pin Characteristics

The following table shows MCU pins and their characteristics. All inputs detect CMOS logic levels. All inputs can be put in a high-impedance state, but the method of doing this differs depending upon pin function. Refer to the table, MCU Driver Types, for a description of output drivers. An entry in the discrete I/O column of the MCU Pin Characteristics table indicates that a pin has an alternate I/O function. The port designation is given when it applies. Refer to the MCU Block Diagram for information about port organization.

Table 2 MCU Pin Characteristic

Pin Mnemonic	Output Driver	Input Synchronized	Input Hysteresis	Discrete I/O	Port Designation
ADDR23/$\overline{CS10}$/ECLK	A	Y	N	O	—
ADDR[22:19]/$\overline{CS[9:6]}$	A	Y	N	O	PC[6:3]
ADDR[18:0]	A	Y	N	—	—
$\overline{AS}$	B	Y	N	I/O	PE5
$\overline{AVEC}$	B	Y	N	I/O	PE2
$\overline{BERR}$	B	Y	N	—	—
$\overline{BG}$/$\overline{CS1}$	B	—	—	—	—
$\overline{BGACK}$/$\overline{CS2}$	B	Y	N	—	—
$\overline{BKPT}$/DSCLK	—	Y	Y	—	—
$\overline{BR}$/$\overline{CS0}$	B	Y	N	—	—
CLKOUT	A	—	—	—	—
$\overline{CSBOOT}$	B	—	—	—	—
DATA[15:0][1]	Aw	Y	N	—	—
$\overline{DS}$	B	Y	N	I/O	PE4
$\overline{DSACK1}$	B	Y	N	I/O	PE1
$\overline{DSACK0}$	B	Y	N	I/O	PE0
DSI/$\overline{IFETCH}$	A	Y	Y	—	—
DSO/$\overline{IPIPE}$	A	—	—	—	—
EXTAL[2]	—	—	Special	—	—
FC[2:0]/$\overline{CS[5:3]}$	A	Y	N	O	PC[2:0]
FREEZE/QUOT	A	—	—	—	—
$\overline{HALT}$	Bo	Y	N	—	—
$\overline{IRQ[7:1]}$	B	Y	Y	I/O	PF[7:1]
MISO	Bo	Y	Y	I/O	PQS0
MODCLK[1]	B	Y	N	I/O	PF0
MOSI	Bo	Y	Y	I/O	PQS1
PCS0/$\overline{SS}$	Bo	Y	Y	I/O	PQS3
PCS[3:1]	Bo	Y	Y	I/O	PQS[6:4]
R/$\overline{W}$	A	Y	N	—	—
$\overline{RESET}$	Bo	Y	Y	—	—
$\overline{RMC}$	B	Y	N	I/O	PE3
RXD	—	N	N	—	—
SCK	Bo	Y	Y	I/O	PQS2
SIZ[1:0]	B	Y	N	I/O	PE[7:6]

Table 6 MCU Signal Function (Continued)

Signal Name	Mnemonic	Function
Quotient Out	QUOT	Provides the quotient bit of the polynomial divider
Reset	$\overline{\text{RESET}}$	System reset
Read-Modify-Write Cycle	$\overline{\text{RMC}}$	Indicates an indivisible read-modify-write instruction
Read/Write	R/$\overline{\text{W}}$	Indicates the direction of data transfer on the bus
SCI Receive Data	RXD	Serial input to the SCI
QSPI Serial Clock	SCK	Clock output from QSPI in master mode; clock input to QSPI in slave mode
Size	SIZ[1:0]	Indicates the number of bytes to be transferred during a bus cycle
Slave Select	$\overline{\text{SS}}$	Causes serial transmission when QSPI is in slave mode; causes mode fault in master mode
TCR2 Clock	T2CLK	External clock source for TCR2 counter
TPU Channel Pins	TPUCH[15:0]	Bidirectional pins associated with TPU channels
Three-State Control	TSC	Places all output drivers in a high-impedance state
SCI Transmit Data	TXD	Serial output from the SCI
External Filter Capacitor	XFC	Connection for external phase-locked loop filter capacitor

Table 7 SIM Address Map

Access	Address	15 8	7 0
S	$YFFA00	SIM CONFIGURATION (SIMCR)	
S	$YFFA02	FACTORY TEST (SIMTR)	
S	$YFFA04	CLOCK SYNTHESIZER CONTROL (SYNCR)	
S	$YFFA06	NOT USED	RESET STATUS REGISTER (RSR)
S	$YFFA08	MODULE TEST E (SIMTRE)	
S	$YFFA0A	NOT USED	NOT USED
S	$YFFA0C	NOT USED	NOT USED
S	$YFFA0E	NOT USED	NOT USED
S/U	$YFFA10	NOT USED	PORT E DATA (PORTE0)
S/U	$YFFA12	NOT USED	PORT E DATA (PORTE1)
S/U	$YFFA14	NOT USED	PORT E DATA DIRECTION (DDRE)
S	$YFFA16	NOT USED	PORT E PIN ASSIGNMENT (PEPAR)
S/U	$YFFA18	NOT USED	PORT F DATA (PORTF0)
S/U	$YFFA1A	NOT USED	PORT F DATA (PORTF1)
S/U	$YFFA1C	NOT USED	PORT F DATA DIRECTION (DDRF)
S	$YFFA1E	NOT USED	PORT F PIN ASSIGNMENT (PFPAR)
S	$YFFA20	NOT USED	SYSTEM PROTECTION CONTROL (SYPCR)
S	$YFFA22	PERIODIC INTERRUPT CONTROL (PICR)	
S	$YFFA24	PERIODIC INTERRUPT TIMING (PITR)	
S	$YFFA26	NOT USED	SOFTWARE SERVICE (SWSR)
S	$YFFA28	NOT USED	NOT USED
S	$YFFA2A	NOT USED	NOT USED
S	$YFFA2C	NOT USED	NOT USED
S	$YFFA2E	NOT USED	NOT USED
S	$YFFA30	TEST MODULE MASTER SHIFT A (TSTMSRA)	
S	$YFFA32	TEST MODULE MASTER SHIFT B (TSTMSRB)	
S	$YFFA34	TEST MODULE SHIFT COUNT (TSTSC)	
S	$YFFA36	TEST MODULE REPETITION COUNTER (TSTRC)	
S	$YFFA38	TEST MODULE CONTROL (CREG)	
S/U	$YFFA3A	TEST MODULE DISTRIBUTED REGISTER (DREG)	
	$YFFA3C	NOT USED	NOT USED
	$YFFA3E	NOT USED	NOT USED
S/U	$YFFA40	NOT USED	PORT C DATA (PORTC)
	$YFFA42	NOT USED	NOT USED
S	$YFFA44	CHIP-SELECT PIN ASSIGNMENT (CSPAR0)	
S	$YFFA46	CHIP-SELECT PIN ASSIGNMENT (CSPAR1)	
S	$YFFA48	CHIP-SELECT BASE BOOT (CSBARBT)	
S	$YFFA4A	CHIP-SELECT OPTION BOOT (CSORBT)	
S	$YFFA4C	CHIP-SELECT BASE 0 (CSBAR0)	
S	$YFFA4E	CHIP-SELECT OPTION 0 (CSOR0)	
S	$YFFA50	CHIP-SELECT BASE 1 (CSBAR1)	
S	$YFFA52	CHIP-SELECT OPTION 1 (CSOR1)	
S	$YFFA54	CHIP-SELECT BASE 2 (CSBAR2)	

Table 7 SIM Address Map (Continued)

Access	Address	15 8	7 0
S	$YFFA56	CHIP-SELECT OPTION 2 (CSOR2)	
S	$YFFA58	CHIP-SELECT BASE 3 (CSBAR3)	
S	$YFFA5A	CHIP-SELECT OPTION 3 (CSOR3)	
S	$YFFA5C	CHIP-SELECT BASE 4 (CSBAR4)	
S	$YFFA5E	CHIP-SELECT OPTION 4 (CSOR4)	
S	$YFFA60	CHIP-SELECT BASE 5 (CSBAR5)	
S	$YFFA62	CHIP-SELECT OPTION 5 (CSOR5)	
S	$YFFA64	CHIP-SELECT BASE 6 (CSBAR6)	
S	$YFFA66	CHIP-SELECT OPTION 6 (CSOR6)	
S	$YFFA68	CHIP-SELECT BASE 7 (CSBAR7)	
S	$YFFA6A	CHIP-SELECT OPTION 7 (CSOR7)	
S	$YFFA6C	CHIP-SELECT BASE 8 (CSBAR8)	
S	$YFFA6E	CHIP-SELECT OPTION 8 (CSOR8)	
S	$YFFA70	CHIP-SELECT BASE 9 (CSBAR9)	
S	$YFFA72	CHIP-SELECT OPTION 9 (CSOR9)	
S	$YFFA74	CHIP-SELECT BASE 10 (CSBAR10)	
S	$YFFA76	CHIP-SELECT OPTION 10 (CSOR10)	
	$YFFA78	NOT USED	NOT USED
	$YFFA7A	NOT USED	NOT USED
	$YFFA7C	NOT USED	NOT USED
	$YFFA7E	NOT USED	NOT USED

Y = M111, where M is the logic state of the module mapping (MM) bit in the SIMCR.

3.2 System Configuration and Protection

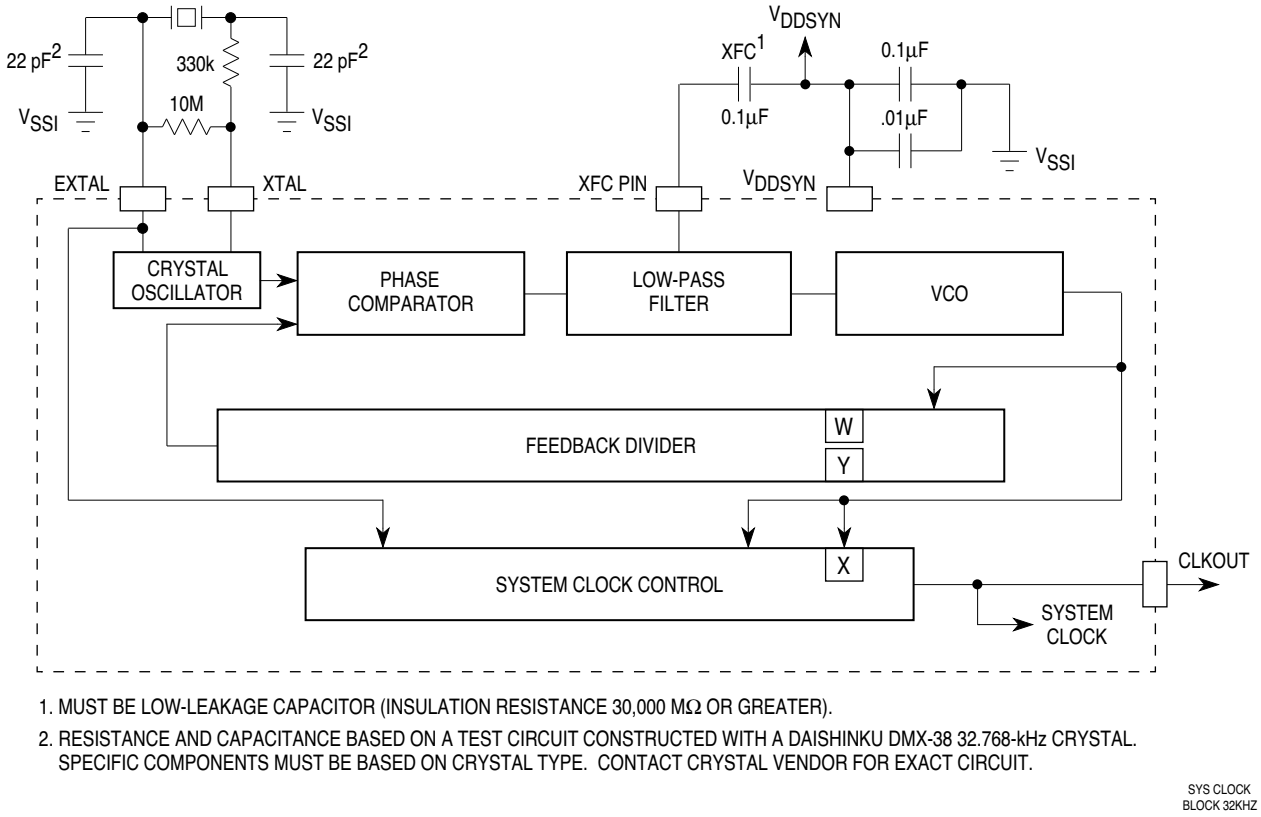
This functional block provides configuration control for the entire MCU. It also performs interrupt arbitration, bus monitoring, and system test functions. MCU system protection includes a bus monitor, a HALT monitor, a spurious interrupt monitor, and a software watchdog timer. These functions have been made integral to the microcontroller to reduce the number of external components in a complete control system.

3.3 System Clock

The system clock in the SIM provides timing signals for the IMB modules and for an external peripheral bus. Because MCU operation is fully static, register and memory contents are not affected when the clock rate changes. System hardware and software support changes in the clock rate during operation.

The system clock signal can be generated in three ways. An internal phase-locked loop can synthesize the clock from an internal or external frequency source, or the clock signal can be input from an external source.

Following is a block diagram of the clock submodule.



1. MUST BE LOW-LEAKAGE CAPACITOR (INSULATION RESISTANCE 30,000 MΩ OR GREATER).
2. RESISTANCE AND CAPACITANCE BASED ON A TEST CIRCUIT CONSTRUCTED WITH A DAISHINKU DMX-38 32.768-kHz CRYSTAL. SPECIFIC COMPONENTS MUST BE BASED ON CRYSTAL TYPE. CONTACT CRYSTAL VENDOR FOR EXACT CIRCUIT.

Figure 7 System Clock Block Diagram

3.3.1 Clock Sources

The state of the clock mode (MODCLK) pin during reset determines the clock source. When MODCLK is held high during reset, the clock synthesizer generates a clock signal from either a crystal oscillator or an external reference input. Clock synthesizer control register SYNCR determines operating frequency and various modes of operation. When MODCLK is held low during reset, the clock synthesizer is disabled, and an external system clock signal must be applied. When the synthesizer is disabled, SYNCR control bits have no effect.

A reference crystal must be connected between the EXTAL and XTAL pins to use the internal oscillator. Use of a 32.768-kHz crystal is recommended. These crystals are inexpensive and readily available. If an external reference signal or an external system clock signal is applied through the EXTAL pin, the XTAL pin must be left floating. External reference signal frequency must be less than or equal to maximum specified reference frequency. External system clock signal frequency must be less than or equal to maximum specified system clock frequency.

3.4 External Bus Interface

The external bus interface (EBI) transfers information between the internal MCU bus and external devices. The external bus has 24 address lines and 16 data lines.

The EBI provides dynamic sizing between 8-bit and 16-bit data accesses. It supports byte, word, and long-word transfers. Ports are accessed through the use of asynchronous cycles controlled by the data transfer (SIZ1 and SIZ0) and data size acknowledge pins ($\overline{\text{DSACK1}}$ and $\overline{\text{DSACK0}}$). Multiple bus cycles may be required for a transfer to or from an 8-bit port.

Port width is the maximum number of bits accepted or provided during a bus transfer. External devices must follow the handshake protocol described below. Control signals indicate the beginning of the cycle, the address space, the size of the transfer, and the type of cycle. The selected device controls the length of the cycle. Strobe signals, one for the address bus and another for the data bus, indicate the validity of an address and provide timing information for data. The EBI operates in an asynchronous mode for any port width.

To add flexibility and minimize the necessity for external logic, MCU chip-select logic can be synchronized with EBI transfers. Chip-select logic can also provide internally-generated bus control signals for these accesses. Refer to **3.5 Chip Selects** for more information.

3.4.1 Bus Control Signals

The CPU initiates a bus cycle by driving the address, size, function code, and read/write outputs. At the beginning of the cycle, size signals SIZ0 and SIZ1 are driven along with the function code signals. The size signals indicate the number of bytes remaining to be transferred during an operand cycle. They are valid while the address strobe ($\overline{\text{AS}}$) is asserted. The following table shows SIZ0 and SIZ1 encoding. The read/write (R/$\overline{\text{W}}$) signal determines the direction of the transfer during a bus cycle. This signal changes state, when required, at the beginning of a bus cycle, and is valid while $\overline{\text{AS}}$ is asserted. R/$\overline{\text{W}}$ only changes state when a write cycle is preceded by a read cycle or vice versa. The signal can remain low for two consecutive write cycles.

Table 8 Size Signal Encoding

SIZ1	SIZ0	Transfer Size
0	1	Byte
1	0	Word
1	1	Three Byte
0	0	Long Word

3.4.2 Function Codes

The CPU32 automatically generates function code signals FC[2:0]. The function codes can be considered address extensions that automatically select one of eight address spaces to which an address applies. These spaces are designated as either user or supervisor, and program or data spaces. Address space 7 is designated CPU space. CPU space is used for control information not normally associated with read or write bus cycles. Function codes are valid while $\overline{\text{AS}}$ is asserted.

PFPAR — Port F Pin Assignment Register **$YFFA1F**

15 … 8	7	6	5	4	3	2	1	0
NOT USED	PFPA7	PFPA6	PFPA5	PFPA4	PFPA3	PFPA2	PFPA1	PFPA0
RESET:	DATA9	DATA9	DATA9	DATA9	DATA9	DATA9	DATA9	DATA9

The bits in this register control the function of each port F pin. Any bit cleared to zero defines the corresponding pin to be an I/O pin. Any bit set to one defines the corresponding pin to be an interrupt request signal or MODCLK. The MODCLK signal has no function after reset.

Table 17 Port F Pin Assignments

PFPAR Field	Port F Signal	Alternate Signal
PFPA7	PF7	$\overline{\text{IRQ7}}$
PFPA6	PF6	$\overline{\text{IRQ6}}$
PFPA5	PF5	$\overline{\text{IRQ5}}$
PFPA4	PF4	$\overline{\text{IRQ4}}$
PFPA3	PF3	$\overline{\text{IRQ3}}$
PFPA2	PF2	$\overline{\text{IRQ2}}$
PFPA1	PF1	$\overline{\text{IRQ1}}$
PFPA0	PF0	MODCLK

Data bus pin 9 controls the state of this register following reset. If DATA9 is set to one during reset, the register is set to $FF, which defines all port F pins as interrupt request inputs. If DATA9 is cleared to zero during reset, this register is set to $00, defining all port F pins as I/O pins.

3.7 Resets

Reset procedures handle system initialization and recovery from catastrophic failure. The MCU performs resets with a combination of hardware and software. The system integration module determines whether a reset is valid, asserts control signals, performs basic system configuration based on hardware mode-select inputs, then passes control to the CPU.

Reset occurs when an active low logic level on the $\overline{\text{RESET}}$ pin is clocked into the SIM. Resets are gated by the CLKOUT signal. Asynchronous resets are assumed to be catastrophic. An asynchronous reset can occur on any clock edge. Synchronous resets are timed to occur at the end of bus cycles. If there is no clock when $\overline{\text{RESET}}$ is asserted, reset does not occur until the clock starts. Resets are clocked in order to allow completion of write cycles in progress at the time $\overline{\text{RESET}}$ is asserted.

Reset is the highest-priority CPU32 exception. Any processing in progress is aborted by the reset exception, and cannot be restarted. Only essential tasks are performed during reset exception processing. Other initialization tasks must be accomplished by the exception handler routine.

3.7.1 SIM Reset Mode Selection

The logic states of certain data bus pins during reset determine SIM operating configuration. In addition, the state of the MODCLK pin determines system clock source and the state of the $\overline{\text{BKPT}}$ pin determines what happens during subsequent breakpoint assertions. The following table is a summary of reset mode selection options.

Table 18 Reset Mode Selection

Mode Select Pin	Default Function (Pin Left High)	Alternate Function (Pin Pulled Low)

Table 18 Reset Mode Selection

DATA0	$\overline{\text{CSBOOT}}$ 16-Bit	$\overline{\text{CSBOOT}}$ 8-Bit
DATA1	$\overline{\text{CS0}}$ $\overline{\text{CS1}}$ $\overline{\text{CS2}}$	$\overline{\text{BR}}$ $\overline{\text{BG}}$ $\overline{\text{BGACK}}$
DATA2	$\overline{\text{CS3}}$ $\overline{\text{CS4}}$ $\overline{\text{CS5}}$	FC0 FC1 FC2
DATA3 DATA4 DATA5 DATA6 DATA7	$\overline{\text{CS6}}$ $\overline{\text{CS}}[7:6]$ $\overline{\text{CS}}[8:6]$ $\overline{\text{CS}}[9:6]$ $\overline{\text{CS}}[10:6]$	ADDR19 ADDR[20:19] ADDR[21:19] ADDR[22:19] ADDR[23:19]
DATA8	$\overline{\text{DSACK0}}$, $\overline{\text{DSACK1}}$, $\overline{\text{AVEC}}$, $\overline{\text{DS}}$, $\overline{\text{AS}}$, $\overline{\text{SIZ}}[1:0]$	PORTE
DATA9	$\overline{\text{IRQ}}[7:1]$ MODCLK	PORTF
DATA11	Test Mode Disabled	Test Mode Enabled
MODCLK	VCO = System Clock	EXTAL = System Clock
$\overline{\text{BKPT}}$	Background Mode Disabled	Background Mode Enabled

3.7.2 Functions of Pins for Other Modules During Reset

Generally, pins associated with modules other than the SIM default to port functions, and input/output ports are set to input state. This is accomplished by disabling pin functions in the appropriate control registers, and by clearing the appropriate port data direction registers. Refer to individual module sections in this manual for more information. The following table is a summary of module pin function out of reset.

Table 19 Module Pin Functions

Module	Pin Mnemonic	Function
CPU32	DSI/$\overline{\text{IFETCH}}$	DSI/$\overline{\text{IFETCH}}$
	DSO/$\overline{\text{IPIPE}}$	DSO/$\overline{\text{IPIPE}}$
	$\overline{\text{BKPT}}$/DSCLK	$\overline{\text{BKPT}}$/DSCLK
GPT	PGP7/IC4/OC5	Discrete Input
	PGP[6:3]/OC[4:1]	Discrete Input
	PGP[2:0]/IC[3:1]	Discrete Input
	PAI	Discrete Input
	PCLK	Discrete Input
	PWMA, PWMB	Discrete Output
QSM	PQS7/TXD	Discrete Input
	PQS[6:4]/PCS[3:1]	Discrete Input
	PQS3/PCS0/$\overline{\text{SS}}$	Discrete Input
	PQS2/SCK	Discrete Input
	PQS1/MOSI	Discrete Input
	PQS0/MISO	Discrete Input
	RXD	RXD

mask lower-priority interrupts during exception processing, and it is decoded by modules that have requested interrupt service to determine whether the current interrupt acknowledge cycle pertains to them.

Modules that have requested interrupt service decode the IP value placed on the address bus at the beginning of the interrupt acknowledge cycle, and if their requests are at the specified IP level, respond to the cycle. Arbitration between simultaneous requests of the same priority is performed by means of serial contention between module interrupt arbitration (IARB) field bit values.

Each module that can make an interrupt service request, including the SIM, has an IARB field in its configuration register. An IARB field can be assigned a value from %0001 (lowest priority) to %1111 (highest priority). A value of %0000 in an IARB field causes the CPU to process a spurious interrupt exception when an interrupt from that module is recognized.

Because the EBI manages external interrupt requests, the SIM IARB value is used for arbitration between internal and external interrupt requests. The reset value of IARB for the SIM is %1111, and the reset IARB value for all other modules is %0000. Initialization software must assign different IARB values in order to implement an arbitration scheme.

Each module must have a unique IARB value. When two or more IARB fields have the same nonzero value, the CPU interprets multiple vector numbers simultaneously, with unpredictable consequences.

Arbitration must always take place, even when a single source requests service. This point is important for two reasons: the CPU interrupt acknowledge cycle is not driven on the external bus unless the SIM wins contention, and failure to contend causes an interrupt acknowledge bus cycle to be terminated by a bus error, which causes a spurious interrupt exception to be taken.

When arbitration is complete, the dominant module must place an interrupt vector number on the data bus and terminate the bus cycle. In the case of an external interrupt request, because the interrupt acknowledge cycle is transferred to the external bus, an external device must decode the mask value and respond with a vector number, then generate bus cycle termination signals. If the device does not respond in time, a spurious interrupt exception is taken.

The periodic interrupt timer (PIT) in the SIM can generate internal interrupt requests of specific priority at predetermined intervals. By hardware convention, PIT interrupts are serviced before external interrupt service requests of the same priority. Refer to 3.2.7 Periodic Interrupt Timer for more information.

3.8.2 Interrupt Processing Summary

A summary of the interrupt processing sequence follows. When the sequence begins, a valid interrupt service request has been detected and is pending.

A. The CPU finishes higher priority exception processing or reaches an instruction boundary.
B. Processor state is stacked. The contents of the status register and program counter are saved.
C. The interrupt acknowledge cycle begins:
    1. FC[2:0] are driven to %111 (CPU space) encoding.
    2. The address bus is driven as follows. ADDR[23:20] = %1111; ADDR[19:16] = %1111, which indicates that the cycle is an interrupt acknowledge CPU space cycle; ADDR[15:4] = %111111111111; ADDR[3:1] = the level of the interrupt request being acknowledged; and ADDR0 = %1.
    3. Request priority level is latched into the IP field in the status register from the address bus.
D. Modules or external peripherals that have requested interrupt service decode the request level in ADDR[3:1]. If the request level of at least one interrupting module or device is the same as the value in ADDR[3:1], interrupt arbitration contention takes place. When there is no contention, the spurious interrupt monitor asserts $\overline{\text{BERR}}$, and a spurious interrupt exception is processed.
E. After arbitration, the interrupt acknowledge cycle can be completed in one of three ways:

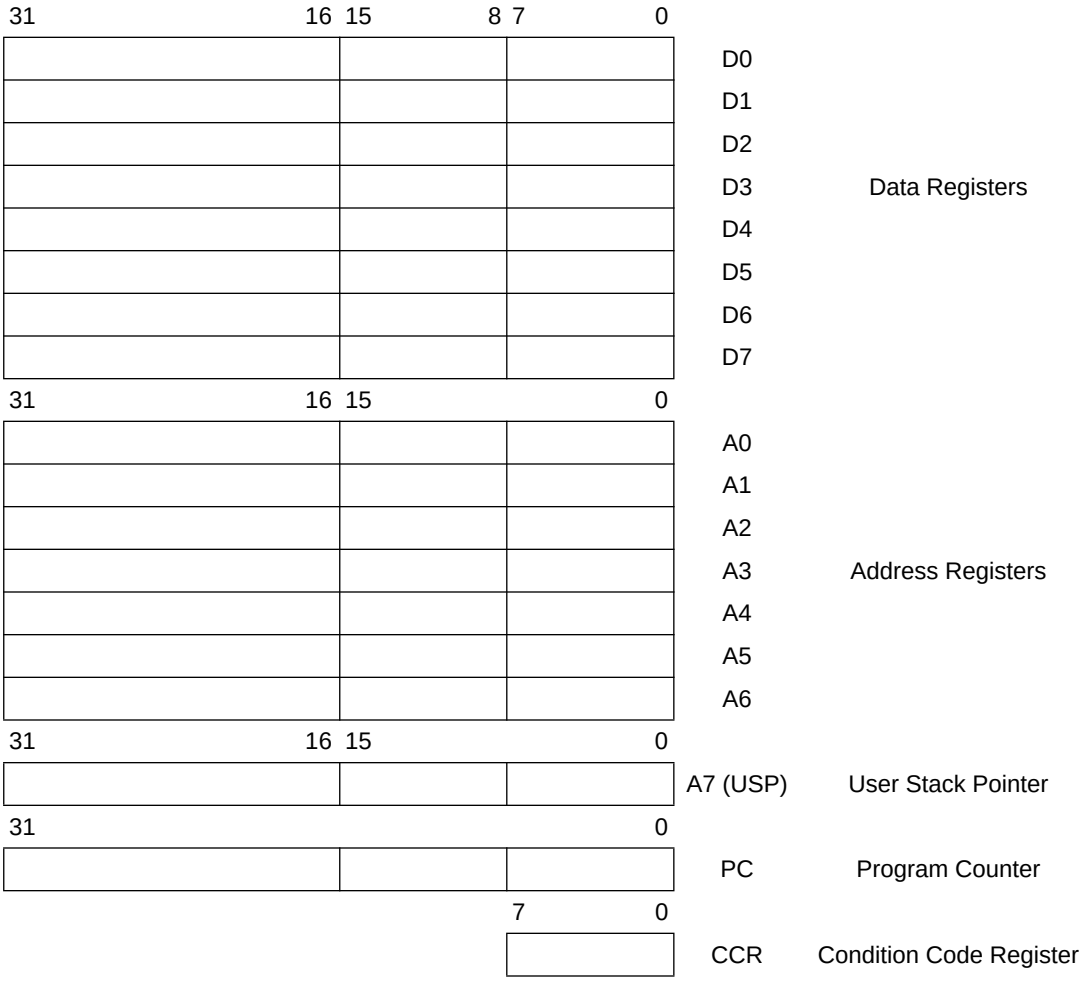


Figure 10 User Programming Model

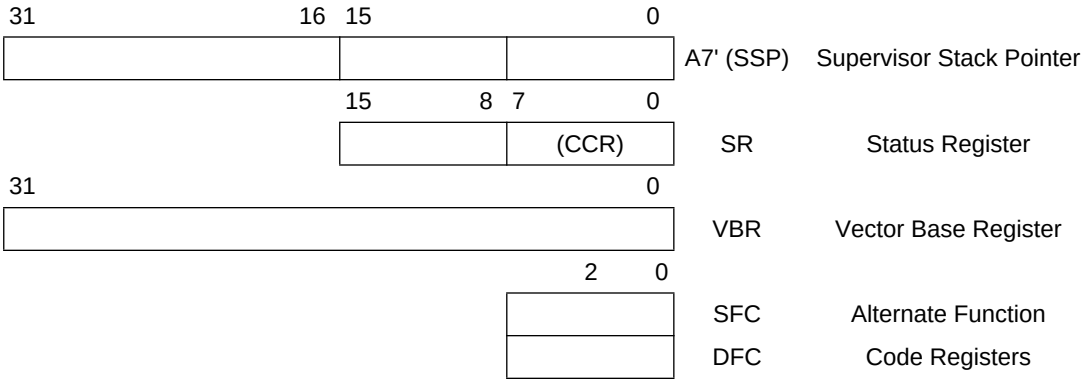
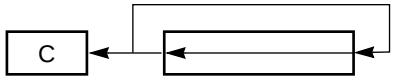
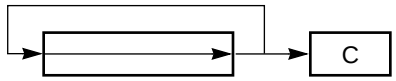
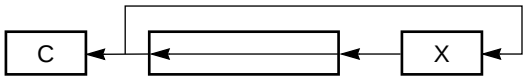
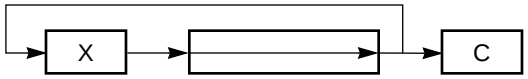


Figure 11 Supervisor Programming Model Supplement

Table 20 Instruction Set Summary(Continued)

Instruction	Syntax	Operand Size	Operation
MOVES[1]	Rn, <ea> <ea>, Rn	8, 16, 32	Rn ⇒ Destination using DFC Source using SFC ⇒ Rn
MULS/MULU	<ea>, Dn <ea>, Dl <ea>, Dh : Dl	16 ∗ 16 ⇒ 32 32 ∗ 32 ⇒ 32 32 ∗ 32 ⇒ 64	Source ∗ Destination ⇒ Destination (signed or unsigned)
NBCD	Í	8 8	0 – Destination$_{10}$ – X ⇒ Destination
NEG	Í	8, 16, 32	0 – Destination ⇒ Destination
NEGX	Í	8, 16, 32	0 – Destination – X ⇒ Destination
NOP	none	none	PC + 2 ⇒ PC
NOT	Í	8, 16, 32	$\overline{\text{Destination}}$ ⇒ Destination
OR	<ea>, Dn Dn, <ea>	8, 16, 32 8, 16, 32	Source + Destination ⇒ Destination
ORI	#<data>, <ea>	8, 16, 32	Data + Destination ⇒ Destination
ORI to CCR	#<data>, CCR	16	Source + CCR ⇒ SR
ORI to SR[1]	#<data>, SR	16	Source ; SR ⇒ SR
PEA	Í	32	SP – 4 ⇒ SP; <ea> ⇒ SP
RESET[1]	none	none	Assert $\overline{\text{RESET}}$ line
ROL	Dn, Dn #<data>, Dn Í	8, 16, 32 8, 16, 32 16	
ROR	Dn, Dn #<data>, Dn Í	8, 16, 32 8, 16, 32 16	
ROXL	Dn, Dn #<data>, Dn Í	8, 16, 32 8, 16, 32 16	
ROXR	Dn, Dn #<data>, Dn Í	8, 16, 32 8, 16, 32 16	
RTD	#d	16	(SP) ⇒ PC; SP + 4 + d ⇒ SP
RTE[1]	none	none	(SP) ⇒ SR; SP + 2 ⇒ SP; (SP) ⇒ PC; SP + 4 ⇒ SP; Restore stack according to format
RTR	none	none	(SP) ⇒ CCR; SP + 2 ⇒ SP; (SP) ⇒ PC; SP + 4 ⇒ SP
RTS	none	none	(SP) ⇒ PC; SP + 4 ⇒ SP
SBCD	Dn, Dn – (An), – (An)	8 8	Destination10 – Source10 – X ⇒ Destination
Scc	Í	8	If condition true, then destination bits are set to 1; else, destination bits are cleared to 0
STOP[1]	#<data>	16	Data ⇒ SR; STOP
SUB	<ea>, Dn Dn, <ea>	8, 16, 32	Destination – Source ⇒ Destination
SUBA	<ea>, An	16, 32	Destination – Source ⇒ Destination
SUBI	#<data>, <ea>	8, 16, 32	Destination – Data ⇒ Destination
SUBQ	#<data>, <ea>	8, 16, 32	Destination – Data ⇒ Destination
SUBX	Dn, Dn – (An), – (An)	8, 16, 32 8, 16, 32	Destination – Source – X ⇒ Destination

4.7 Background Debugging Mode

The background debugger on the CPU32 is implemented in CPU microcode. The background debugging commands are summarized below.

Table 21 Background Debuggung Mode

Command	Mnemonic	Description
Read D/A Register	RDREG/RAREG	Read the selected address or data register and return the results through the serial interface.
Write D/A Register	WDREG/WAREG	The data operand is written to the specified address or data register.
Read System Register	RSREG	The specified system control register is read. All registers that can be read in supervisor mode can be read in background mode.
Write System Register	WSREG	The operand data is written into the specified system control register.
Read Memory Location	READ	Read the sized data at the memory location specified by the long-word address. The source function code register (SFC) determines the address space accessed.
Write Memory Location	WRITE	Write the operand data to the memory location specified by the long-word address. The destination function code (DFC) register determines the address space accessed.
Dump Memory Block	DUMP	Used in conjunction with the READ command to dump large blocks of memory. An initial READ is executed to set up the starting address of the block and retrieve the first result. Subsequent operands are retrieved with the DUMP command.
Fill Memory Block	FILL	Used in conjunction with the WRITE command to fill large blocks of memory. Initially, a WRITE is executed to set up the starting address of the block and supply the first operand. The FILL command writes subsequent operands.
Resume Execution	GO	The pipe is flushed and refilled before resuming instruction execution at the current PC.
Patch User Code	CALL	Current program counter is stacked at the location of the current stack pointer. Instruction execution begins at user patch code.
Reset Peripherals	RST	Asserts RESET for 512 clock cycles. The CPU is not reset by this command. Synonymous with the CPU RESET instruction.
No Operation	NOP	NOP performs no operation and can be used as a null command.

5 Time Processor Unit

The time processor unit (TPU) provides optimum performance in controlling time-related activity. The TPU contains a dedicated execution unit, a tri-level prioritized scheduler, data storage RAM, dual-time bases, and microcode ROM. The TPU controls 16 independent, orthogonal channels, each with an associated I/O pin, and is capable of performing any microcoded time function. Each channel contains dedicated hardware that allows input or output events to occur simultaneously on all channels.

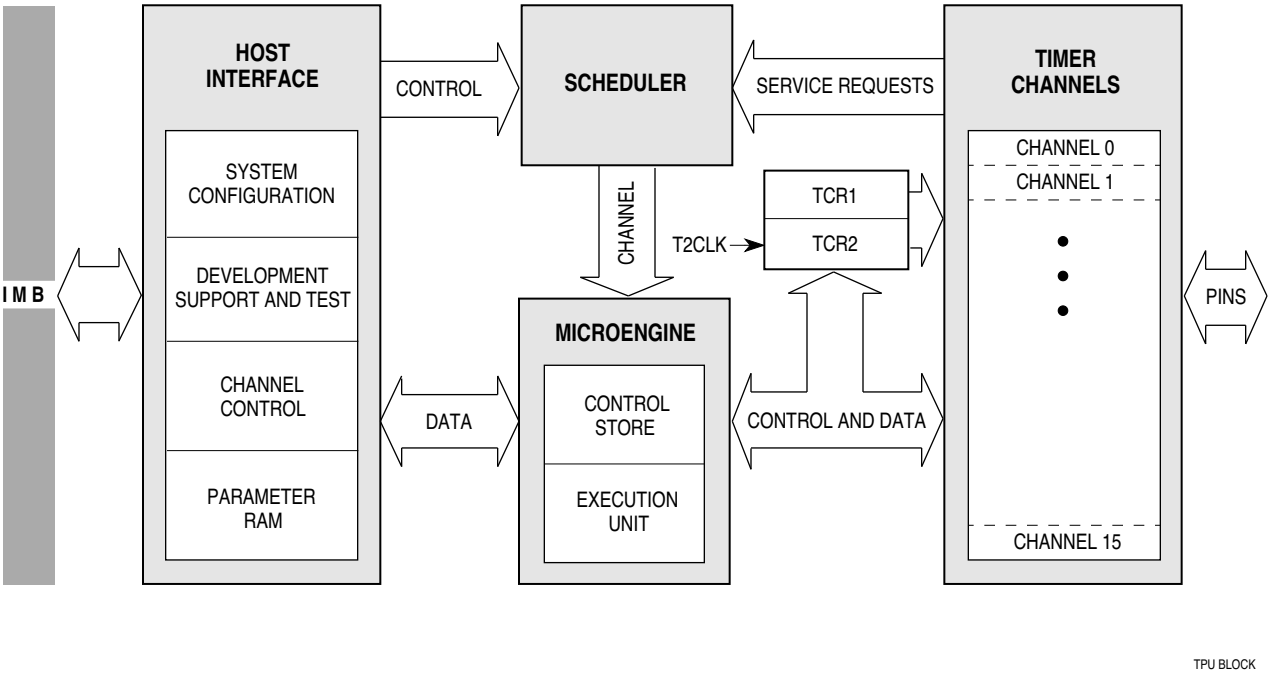


Figure 12 TPU Block Diagram

5.1 MC68332 and MC68332A Time Functions

The following paragraphs describe factory-programmed time functions implemented in standard and enhanced standard TPU microcode ROM. A complete description of the functions is beyond the scope of this summary. Refer to *Using the TPU Function Library and TPU Emulation Mode* (TPUPN00/D) as well as other TPU programming notes for more information about specific functions.

5.1.1 Discrete Input/Output (DIO)

When a pin is used as a discrete input, a parameter indicates the current input level and the previous 15 levels of a pin. Bit 15, the most significant bit of the parameter, indicates the most recent state. Bit 14 indicates the next most recent state, and so on. The programmer can choose one of the three following conditions to update the parameter: 1) when a transition occurs, 2) when the CPU makes a request, or 3) when a rate specified in another parameter is matched. When a pin is used as a discrete output, it is set high or low only upon request by the CPU.

5.1.2 Input Capture/Input Transition Counter (ITC)

Any channel of the TPU can capture the value of a specified TCR upon the occurrence of each transition or specified number of transitions, and then generate an interrupt request to notify the CPU. A channel can perform input captures continually, or a channel can detect a single transition or specified number of transitions, then cease channel activity until reinitialization. After each transition or specified number of transitions, the channel can generate a link to a sequential block of up to eight channels. The user specifies a starting channel of the block and the number of channels within the block. The generation of links depends on the mode of operation. In addition, after each transition or specified number of transitions, one byte of the parameter RAM (at an address specified by channel parameter) can be incremented and used as a flag to notify another channel of a transition.

5.1.3 Output Compare (OC)

The output compare function generates a rising edge, falling edge, or a toggle of the previous edge in one of three ways:

1. Immediately upon CPU initiation, thereby generating a pulse with a length equal to a programmable delay time.
2. At a programmable delay time from a user-specified time.
3. Continuously. Upon receiving a link from a channel, OC references, without CPU interaction, a specifiable period and calculates an offset:

$$\text{Offset} = \text{Period} * \text{Ratio}$$

where Ratio is a parameter supplied by the user.

This algorithm generates a 50% duty-cycle continuous square wave with each high/low time equal to the calculated OFFSET. Due to offset calculation, there is an initial link time before continuous pulse generation begins.

5.1.4 Pulse-Width Modulation (PWM)

The TPU can generate a pulse-width modulation waveform with any duty cycle from zero to 100% (within the resolution and latency capability of the TPU). To define the PWM, the CPU provides one parameter that indicates the period and another parameter that indicates the high time. Updates to one or both of these parameters can direct the waveform change to take effect immediately, or coherently beginning at the next low-to-high transition of the pin.

5.1.5 Synchronized Pulse-Width Modulation (SPWM)

The TPU generates a PWM waveform in which the CPU can change the period and/or high time at any time. When synchronized to a time function on a second channel, the synchronized PWM low-to-high transitions have a time relationship to transitions on the second channel.

5.1.6 Period Measurement with Additional Transition Detect (PMA)

This function and the following function are used primarily in toothed-wheel speed-sensing applications, such as monitoring rotational speed of an engine. The period measurement with additional transition detect function allows for a special-purpose 23-bit period measurement. It can detect the occurrence of an additional transition (caused by an extra tooth on the sensed wheel) indicated by a period measurement that is less than a programmable ratio of the previous period measurement.

Once detected, this condition can be counted and compared to a programmable number of additional transitions detected before TCR2 is reset to $FFFF. Alternatively, a byte at an address specified by a channel parameter can be read and used as a flag. A nonzero value of the flag indicates that TCR2 is to be reset to $FFFF once the next additional transition is detected.

lation parameter. From 1 to 255 period measurements can be made and summed with the previous measurement(s) before the TPU interrupts the CPU, allowing instantaneous or average frequency measurement, and the latest complete accumulation (over the programmed number of periods).

The pulse width (high-time portion) of an input signal can be measured (up to 24 bits) and added to a previous measurement over a programmable number of periods (1 to 255). This provides an instantaneous or average pulse-width measurement capability, allowing the latest complete accumulation (over the specified number of periods) to always be available in a parameter. By using the output compare function in conjunction with PPWA, an output signal can be generated that is proportional to a specified input signal. The ratio of the input and output frequency is programmable. One or more output signals with different frequencies, yet proportional and synchronized to a single input signal, can be generated on separate channels.

5.1.11 Quadrature Decode (QDEC)

The quadrature decode function uses two channels to decode a pair of out-of-phase signals in order to present the CPU with directional information and a position value. It is particularly suitable for use with slotted encoders employed in motor control. The function derives full resolution from the encoder signals and provides a 16-bit position counter with rollover/under indication via an interrupt.

The counter in parameter RAM is updated when a valid transition is detected on either one of the two inputs. The counter is incremented or decremented depending on the lead/lag relationship of the two signals at the time of servicing the transition. The user can read or write the counter at any time. The counter is free running, overflowing to $0000 or underflowing to $FFFF depending on direction. The QDEC function also provides a time stamp referenced to TCR1 for every valid signal edge and the ability for the host CPU to obtain the latest TCR1 value. This feature allows position interpolation by the host CPU between counts at very slow count rates.

5.2 MC68332G Time Functions

The following paragraphs describe factory-programmed time functions implemented in the motion-control microcode ROM. A complete description of the functions is beyond the scope of this summary. Refer to *Using the TPU Function Library and TPU Emulation Mode* (TPUPN00/D) for more information about specific functions.

5.2.1 Table Stepper Motor (TSM)

The TSM function provides for acceleration and deceleration control of a stepper motor with a programmable number of step rates up to 58. TSM uses a table in PRAM, rather than an algorithm, to define the stepper motor acceleration profile, allowing the user to fully define the profile. In addition, a slew rate parameter allows fine control of the terminal running speed of the motor independent of the acceleration table. The CPU need only write a desired position, and the TPU accelerates, slews, and decelerates the motor to the required position. Full and half step support is provided for two-phase motors. In addition, a slew rate parameter allows fine control of the terminal running speed of the motor independent of the acceleration table.

5.2.2 New Input Capture/Transition Counter (NITC)

Any channel of the TPU can capture the value of a specified TCR or any specified location in parameter RAM upon the occurrence of each transition or specified number of transitions, and then generate an interrupt request to notify the bus master. The times of the most recent two transitions are maintained in parameter RAM. A channel can perform input captures continually, or a channel can detect a single transition or specified number of transitions, ceasing channel activity until reinitialization. After each transition or specified number of transitions, the channel can generate a link to other channels.

CHX[1:0]	Service	Guaranteed Time Slots
00	Disabled	—
01	Low	4 out of 7
10	Middle	2 out of 7
11	High	1 out of 7

5.5.3 Development Support and Test Registers

These registers are used for custom microcode development or for factory test. Describing the use of the registers is beyond the scope of this technical summary. Register names and addresses are given for reference only. Please refer to the *TPU Reference Manual* (TPURM/AD) for more information.

DSCR — Development Support Control Register **$YFFE04**

DSSR — Development Support Status Register **$YFFE06**

LR — Link Register **$YFFE22**

SGLR — Service Grant Latch Register **$YFFE24**

DCNR — Decoded Channel Number Register **$YFFE26**

TCR — Test Configuration Register **$YFFE02**

The TCR is used for factory test of the MCU.

HALT — Halt

0 = Halt not enabled

1 = Halt enabled

When HALT is asserted, the QSPI stops on a queue boundary. It is in a defined state from which it can later be restarted.

SPSR — QSPI Status Register **$YFFC1F**

15 … 8	7	6	5	4	3 … 0
SPCR3	SPIF	MODF	HALTA	0	CPTQP
RESET:					
	0	0	0	0	0 0 0 0

SPSR contains QSPI status information. Only the QSPI can assert the bits in this register. The CPU reads this register to obtain status information and writes it to clear status flags.

SPIF — QSPI Finished Flag

0 = QSPI not finished

1 = QSPI finished

SPIF is set after execution of the command at the address in ENDQP.

MODF — Mode Fault Flag

0 = Normal operation

1 = Another SPI node requested to become the network SPI master while the QSPI was enabled in master mode ($\overline{SS}$ input taken low).

The QSPI asserts MODF when the QSPI is the serial master (MSTR = 1) and the $\overline{SS}$ input pin is negated by an external driver.

HALTA — Halt Acknowledge Flag

0 = QSPI not halted

1 = QSPI halted

HALTA is asserted when the QSPI halts in response to CPU assertion of HALT.

Bit 4 — Not Implemented

CPTQP — Completed Queue Pointer

CPTQP points to the last command executed. It is updated when the current command is complete. When the first command in a queue is executing, CPTQP contains either the reset value ($0) or a pointer to the last command completed in the previous queue.

6.5.3 QSPI RAM

The QSPI contains an 80-byte block of dual-access static RAM that is used by both the QSPI and the CPU. The RAM is divided into three segments: receive data, transmit data, and command control data. Receive data is information received from a serial device external to the MCU. Transmit data is information stored by the CPU for transmission to an external peripheral. Command control data is used to perform the transfer.

Refer to the following illustration of the organization of the RAM.

Writing a value of zero to SCBR disables the baud rate generator.

The following table lists the SCBR settings for standard and maximum baud rates using 16.78-MHz and 20.97-MHz system clocks.

Table 27 SCI Baud Rates

Nominal Baud Rate	Actual Rate with 16.78-MHz Clock	SCBR Value	Actual Rate with 20.97-MHz Clock	SCBR Value
64*	64.0	$1FFF	—	—
110	110.0	$129E	110.0	$1745
300	299.9	$06D4	300.1	$0888
600	599.9	$036A	600.1	$0444
1200	1199.7	$0165	1200.3	$0222
2400	2405.0	$00DA	2400.6	$0111
4800	4810.0	$006D	4783.6	$0089
9600	9532.5	$0037	9637.6	$0044
19200	19418.1	$0016	19275.3	$0022
38400	37449.1	$000E	38550.6	$0011
76800	74898.3	$0007	72817.8	$0009
Maximum Rate	524288.0	$0001	655360.0	$0001

SCCR1 — SCI Control Register 1 **$YFFC0A**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	LOOPS	WOMS	ILT	PT	PE	M	WAKE	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
RESET:															
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

SCCR1 contains SCI configuration parameters. The CPU can read and write this register at any time. The SCI can modify RWU in some circumstances. In general, interrupts enabled by these control bits are cleared by reading SCSR, then reading (receiver status bits) or writing (transmitter status bits) SCDR.

Bit 15 — Not Implemented

LOOPS — Loop Mode

0 = Normal SCI operation, no looping, feedback path disabled
1 = Test SCI operation, looping, feedback path enabled

LOOPS controls a feedback path on the data serial shifter. When loop mode is enabled, SCI transmitter output is fed back into the receive serial shifter. TXD is asserted (idle line). Both transmitter and receiver must be enabled before entering loop mode.

WOMS — Wired-OR Mode for SCI Pins

0 = If configured as an output, TXD is a normal CMOS output.
1 = If configured as an output, TXD is an open-drain output.

WOMS determines whether the TXD pin is an open-drain output or a normal CMOS output. This bit is used only when TXD is an output. If TXD is used as a general-purpose input pin, WOMS has no effect.

ILT — Idle-Line Detect Type

0 = Short idle-line detect (start count on first one)
1 = Long idle-line detect (start count on first one after stop bit(s))

PT — Parity Type

0 = Even parity
1 = Odd parity

When parity is enabled, PT determines whether parity is even or odd for both the receiver and the transmitter.

SBK — Send Break

0 = Normal operation

1 = Break frame(s) transmitted after completion of current frame

SBK provides the ability to transmit a break code from the SCI. If the SCI is transmitting when SBK is set, it will transmit continuous frames of zeros after it completes the current frame, until SBK is cleared. If SBK is toggled (one to zero in less than one frame interval), the transmitter sends only one or two break frames before reverting to idle line or beginning to send data.

SCSR — SCI Status Register **$YFFC0C**

15 … 9	8	7	6	5	4	3	2	1	0
NOT USED	TDRE	TC	RDRF	RAF	IDLE	OR	NF	FE	PF
RESET:	1	1	0	0	0	0	0	0	0

SCSR contains flags that show SCI operational conditions. These flags can be cleared either by hardware or by a special acknowledgment sequence. The sequence consists of SCSR read with flags set, followed by SCDR read (write in the case of TDRE and TC). A long-word read can consecutively access both SCSR and SCDR. This action clears receive status flag bits that were set at the time of the read, but does not clear TDRE or TC flags.

If an internal SCI signal for setting a status bit comes after the CPU has read the asserted status bits, but before the CPU has written or read register SCDR, the newly set status bit is not cleared. SCSR must be read again with the bit set. Also, SCDR must be written or read before the status bit is cleared.

Reading either byte of SCSR causes all 16 bits to be accessed. Any status bit already set in either byte will be cleared on a subsequent read or write of register SCDR.

TDRE — Transmit Data Register Empty Flag

0 = Register TDR still contains data to be sent to the transmit serial shifter.

1 = A new character can now be written to register TDR.

TDRE is set when the byte in register TDR is transferred to the transmit serial shifter. If TDRE is zero, transfer has not occurred and a write to TDR will overwrite the previous value. New data is not transmitted if TDR is written without first clearing TDRE.

TC — Transmit Complete Flag

0 = SCI transmitter is busy

1 = SCI transmitter is idle

TC is set when the transmitter finishes shifting out all data, queued preambles (mark/idle line), or queued breaks (logic zero). The interrupt can be cleared by reading SCSR when TC is set and then by writing the transmit data register (TDR) of SCDR.

RDRF — Receive Data Register Full Flag

0 = Register RDR is empty or contains previously read data.

1 = Register RDR contains new data.

RDRF is set when the content of the receive serial shifter is transferred to the RDR. If one or more errors are detected in the received word, flag(s) NF, FE, and/or PF are set within the same clock cycle.

RAF — Receiver Active Flag

0 = SCI receiver is idle

1 = SCI receiver is busy

RAF indicates whether the SCI receiver is busy. It is set when the receiver detects a possible start bit and is cleared when the chosen type of idle line is detected. RAF can be used to reduce collisions in systems with multiple masters.